

APPLICATION DATA SHEET

Application Information

Application number::

Filing Date:: 03/20/02

Application Type:: Regular

Subject Matter:: Utility

Suggested Classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks:: None

Number of copies of CDs:: None

Sequence submission::

Computer Readable Form (CRF):: No

Number of copies of CRF:: None

Title:: FLIP CHIP PACKAGE, CIRCUIT  
BOARD THEREOF AND PACKAGING  
METHOD THEREOF

Attorney Docket Number:: YMOR:242

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure:: 1

Total Drawing Sheets:: 3

Small Entity:: No

Latin Name::

Variety denomination name::

Petition included:: No

Petition Type:: None

Licensed US Govt. Agency:: None

Contract or Grant Numbers:: None

Secrecy Order in Parent Appln.?:: No

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Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship	
Country::	Japan
Status::	Full Capacity
Given Name::	Kenji
Middle Name::	
Family Name::	Morimoto
Name Suffix::	
City of Residence::	Saijo-shi
State or Province of	
Residence::	Ehime
Country of Residence::	Japan
Street of mailing address::	c/o Matsushita-Kotobuki Elec.
	Ind. Ltd., 8-1 Furuji-machi
City of mailing address::	Takamatsu-shi
State or Province of	
mailing address::	Kagawa
Country of mailing address::	Japan
Postal or Zip Code of	
mailing address::	760-0025

Given Name:: Hiroshi  
 Middle Name::  
 Family Name:: Ochi  
 Name Suffix::  
 City of Residence:: Saijo-shi  
 State or Province of Residence:: Ehime  
 Country of Residence:: Japan  
 Street of mailing address:: c/o Matsushita-Kotobuki Elec.  
 Ind. Ltd., 8-1 Furujin-machi  
 City of mailing address:: Takamatsu-shi  
 State or Province of mailing address:: Kagawa  
 Country of mailing address:: Japan  
 Postal or Zip Code of mailing address:: 760-0025

#### Correspondence Information

Correspondence Customer Number:: 6160

#### Representative Information

Representative Customer Number:: 6160

#### Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP01/06230	07/18/01

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# **Foreign Priority Information**

<b>Country::</b>	<b>Application number::</b>	<b>Filing Date::</b>	<b>Priority Claimed::</b>
Japan	2000-219911	07/21/00	Yes

## **Assignee Information**

<b>Assignee name::</b>	Matsushita Elec. Ind. Co. Ltd.
<b>Street of mailing address::</b>	1006, Oaza Kadoma
<b>City of mailing address::</b>	Kadoma-shi
<b>State or Province of mailing address::</b>	Osaka
<b>Country of mailing address::</b>	Japan
<b>Postal or Zip Code of mailing address::</b>	571-8501